Lattice Semiconductor Corporation - LFECP10E-4FN484C Datasheet

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

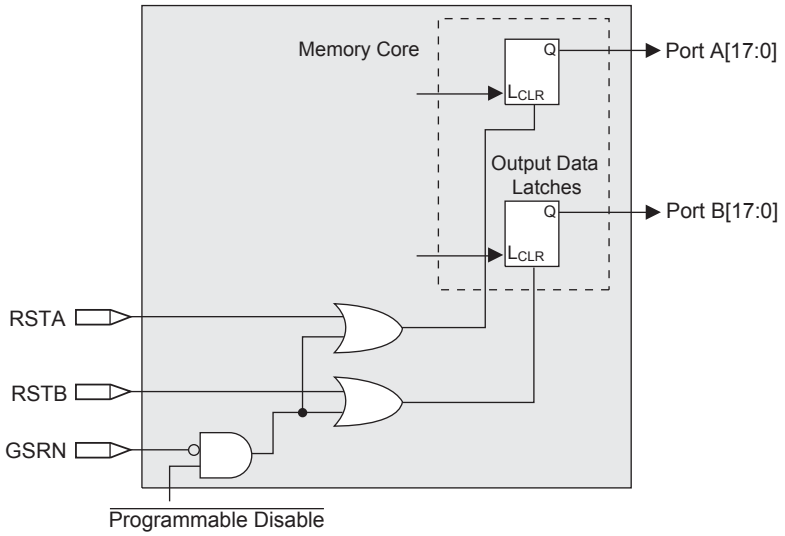
Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	10200
Total RAM Bits	282624
Number of I/O	288
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfecp10e-4fn484c

Figure 2-16. Memory Core Reset

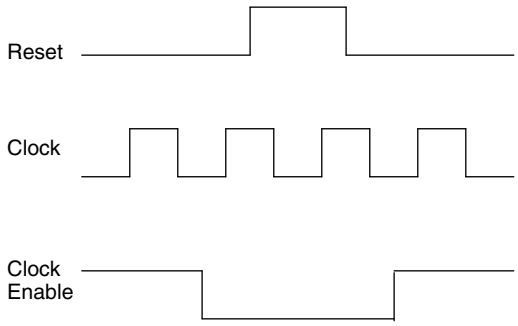


For further information about sysMEM EBR block, please see the the list of technical documentation at the end of this data sheet.

EBR Asynchronous Reset

EBR asynchronous reset or GSR (if used) can only be applied if all clock enables are low for a clock cycle before the reset is applied and released a clock cycle after the reset is released, as shown in Figure 2-17. The GSR input to the EBR is always asynchronous.

Figure 2-17. EBR Asynchronous Reset (Including GSR) Timing Diagram



If all clock enables remain enabled, the EBR asynchronous reset or GSR may only be applied and released after the EBR read and write clock inputs are in a steady state condition for a minimum of $1/f_{MAX}$ (EBR clock). The reset release must adhere to the EBR synchronous reset setup time before the next active read or write clock edge.

If an EBR is pre-loaded during configuration, the GSR input must be disabled or the release of the GSR during device Wake Up must occur before the release of the device I/Os becomes active.

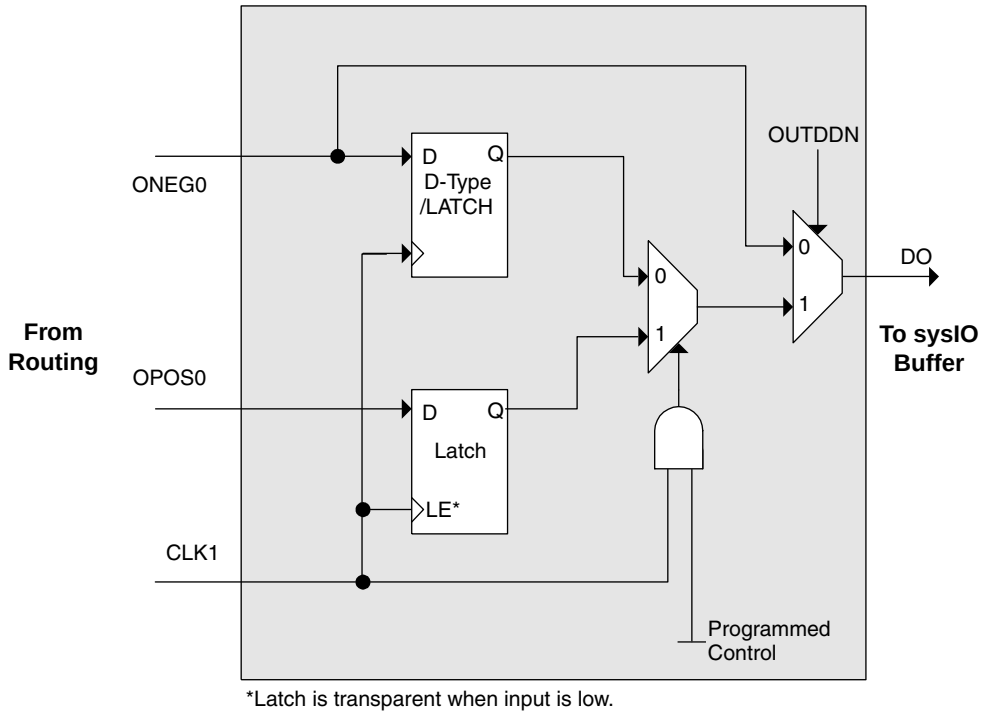
These instructions apply to all EBR RAM and ROM implementations.

Note that there are no reset restrictions if the EBR synchronous reset is used and the EBR GSR input is disabled.

sysDSP Block

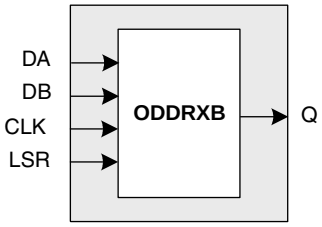
The LatticeECP-DSP family provides a sysDSP block, making it ideally suited for low cost, high performance Digital Signal Processing (DSP) applications. Typical functions used in these applications are Finite Impulse Response (FIR) filters; Fast Fourier Transforms (FFT) functions, correlators, Reed-Solomon/Turbo/Convolution encoders and

Figure 2-29. Output Register Block



*Latch is transparent when input is low.

Figure 2-30. ODDRXB Primitive

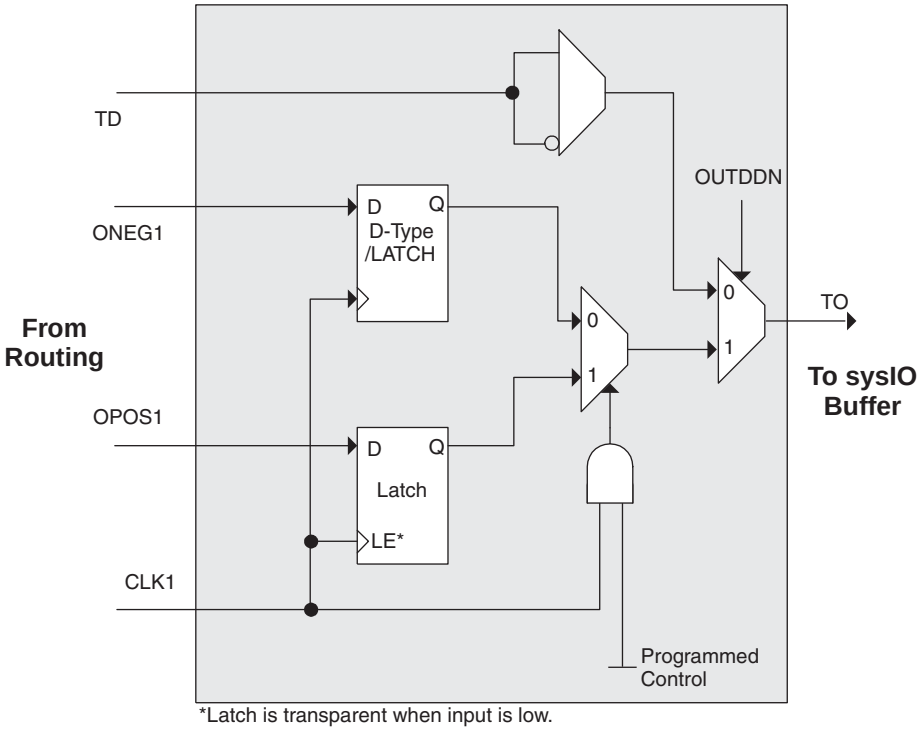


Tristate Register Block

The tristate register block provides the ability to register tri-state control signals from the core of the device before they are passed to the sysI/O buffers. The block contains a register for SDR operation and an additional latch for DDR operation. Figure 2-31 shows the diagram of the Tristate Register Block.

In SDR mode, ONEG1 feeds one of the flip-flops that then feeds the output. The flip-flop can be configured a D-type or latch. In DDR mode, ONEG1 is fed into one register on the positive edge of the clock and OPOS1 is latched. A multiplexer running off the same clock selects the correct register for feeding to the output (D0).

Figure 2-31. Tristate Register Block



*Latch is transparent when input is low.

Control Logic Block

The control logic block allows the selection and modification of control signals for use in the PIO block. A clock is selected from one of the clock signals provided from the general purpose routing and a DQS signal provided from the programmable DQS pin. The clock can optionally be inverted.

The clock enable and local reset signals are selected from the routing and optionally inverted. The global tristate signal is passed through this block.

DDR Memory Support

Implementing high performance DDR memory interfaces requires dedicated DDR register structures in the input (for read operations) and in the output (for write operations). As indicated in the PIO Logic section, the LatticeEC devices provide this capability. In addition to these registers, the LatticeEC devices contain two elements to simplify the design of input structures for read operations: the DQS delay block and polarity control logic.

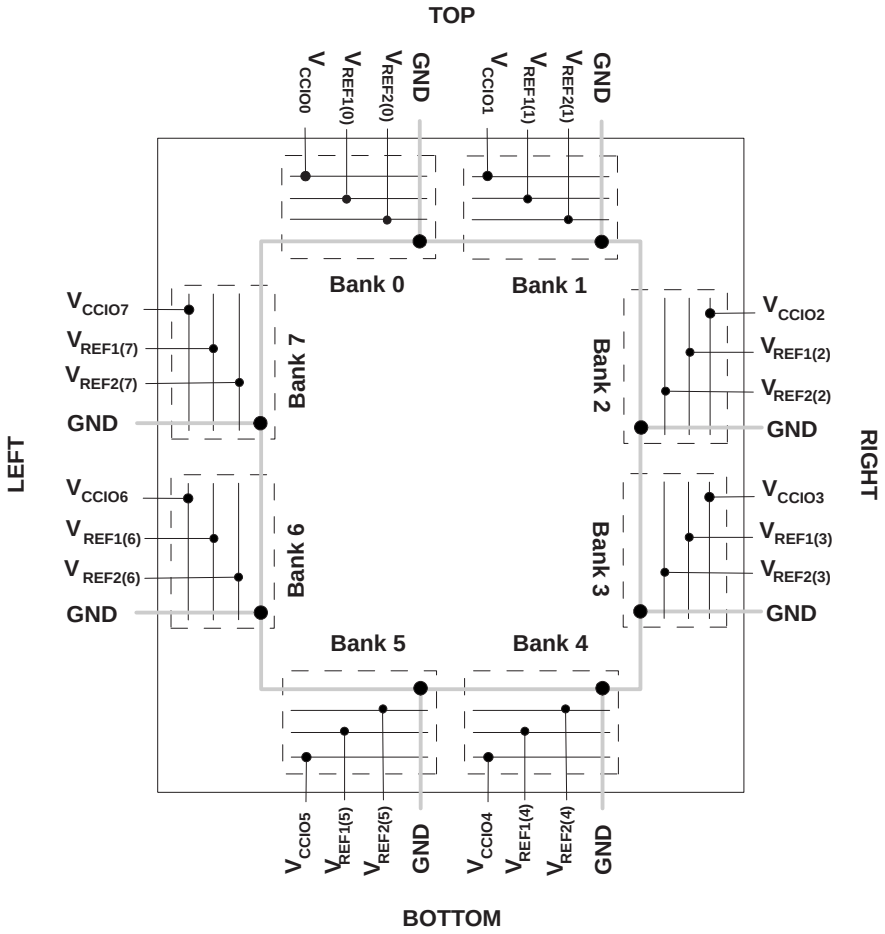
DLL Calibrated DQS Delay Block

Source Synchronous interfaces generally require the input clock to be adjusted in order to correctly capture data at the input register. For most interfaces a PLL is used for this adjustment. However in DDR memories the clock (referred to as DQS) is not free running so this approach cannot be used. The DQS Delay block provides the required clock alignment for DDR memory interfaces.

The DQS signal (selected PIOs only) feeds from the PAD through a DQS delay element to a dedicated DQS routing resource. The DQS signal also feeds polarity control logic, which controls the polarity of the clock to the sync registers in the input register blocks. Figures 2-32 and 2-33 show how the DQS transition signals are routed to the PIOs.

The temperature, voltage and process variations of the DQS delay block are compensated by a set of calibration (6-bit bus) signals from two DLLs on opposite sides of the device. Each DLL compensates DQS Delays in its half of the device as shown in Figure 2-33. The DLL loop is compensated for temperature, voltage and process variations by the system clock and feedback loop.

Figure 2-34. LatticeECP/EC Banks



LatticeECP/EC devices contain two types of sysI/O buffer pairs.

1. **Top and Bottom sysI/O Buffer Pairs (Single-Ended Outputs Only)**
   The sysI/O buffer pairs in the top and bottom banks of the device consist of two single-ended output drivers and two sets of single-ended input buffers (both ratioed and referenced). The referenced input buffer can also be configured as a differential input.

   The two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential input buffer and the comp (complementary) pad is associated with the negative side of the differential input buffer.

   Only the I/Os on the top and bottom banks have programmable PCI clamps. These I/O banks also support hot socketing with IDK less than 1mA. Note that the PCI clamp is enabled after V_{CC}, V_{CCAUX} and V_{CCIO} are at valid operating levels and the device has been configured.

2. **Left and Right sysI/O Buffer Pairs (Differential and Single-Ended Outputs)**
   The sysI/O buffer pairs in the left and right banks of the device consist of two single-ended output drivers, two sets of single-ended input buffers (both ratioed and referenced) and one differential output driver. The referenced input buffer can also be configured as a differential input. In these banks the two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential I/O, and the comp (complementary) pad is associated with the negative side of the differential I/O.

   Only the left and right banks have LVDS differential output drivers. See the I_{DK} specification for I/O leakage current during power-up.

DC Electrical Characteristics

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{IL}, I_{IH}[1]	Input or I/O Leakage	0 ð V_{IN} ð (V_{CCIO} - 0.2V)	—	—	10	µA
I_{IH}[1, 3]	Input or I/O High Leakage	(V_{CCIO} - 0.2V) ð V_{IH} ð 3.6V	—	—	40	µA
I_{PU}	I/O Active Pull-up Current	0 ð V_{IN} ð 0.7 V_{CCIO}	-30	—	-150	µA
I_{PD}	I/O Active Pull-down Current	V_{IL} (MAX) ð V_{IN} ð V_{IH} (MAX)	30	—	150	µA
I_{BHLS}	Bus Hold Low sustaining current	V_{IN} = V_{IL} (MAX)	30	—	—	µA
I_{BHHS}	Bus Hold High sustaining current	V_{IN} = 0.7V_{CCIO}	-30	—	—	µA
I_{BHLO}	Bus Hold Low Overdrive current	0 ð V_{IN} ð V_{IH} (MAX)	—	—	150	µA
I_{BHLH}	Bus Hold High Overdrive current	0 ð V_{IN} ð V_{IH} (MAX)	—	—	-150	µA
V_{BHT}	Bus Hold trip Points	0 ð V_{IN} ð V_{IH} (MAX)	V_{IL} (MAX)	—	V_{IH} (MIN)	V
C1	I/O Capacitance[2]	V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V, V_{CC} = 1.2V, V_{IO} = 0 to V_{IH} (MAX)	—	8	—	pf
C2	Dedicated Input Capacitance[2]	V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V, V_{CC} = 1.2V, V_{IO} = 0 to V_{IH} (MAX)	—	6	—	pf

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.
2. T_A 25°C, f = 1.0MHz
3. For top and bottom general purpose I/O pins, when V_{IH} is higher than V_{CCIO}, a transient current typically of 30ns in duration or less with a peak current of 6mA can occur on the high-to-low transition. For left and right I/O banks, V_{IH} must be less than or equal to V_{CCIO}.

LVPECL

The LatticeECP/EC devices support differential LVPECL standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The LVPECL input standard is supported by the LVDS differential input buffer. The scheme shown in Figure 3-3 is one possible solution for point-to-point signals.

Figure 3-3. Differential LVPECL

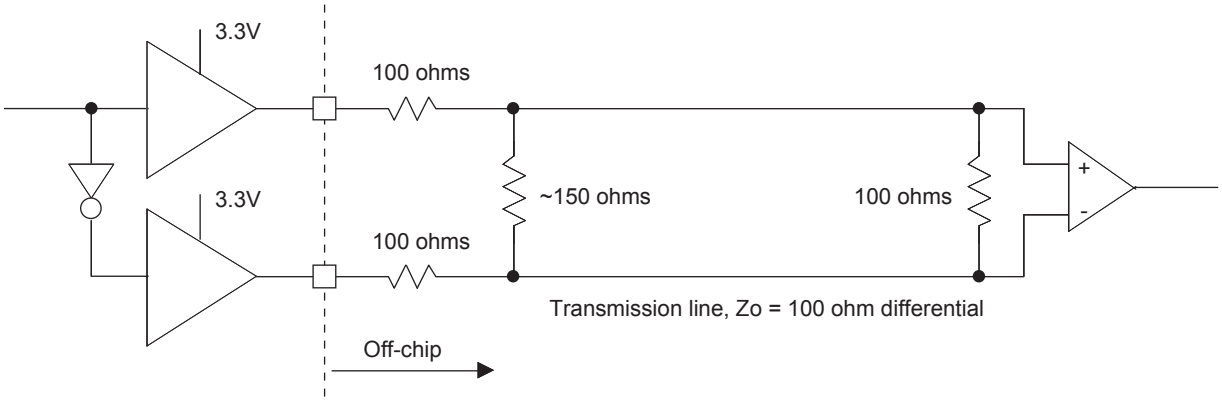


Table 3-3. LVPECL DC Conditions[1]

Over Recommended Operating Conditions

Parameter	Description	Typical	Units
Z_{OUT}	Output impedance	100	ohm
R_P	Driver parallel resistor	150	ohm
R_T	Receiver termination	100	ohm
V_{OH}	Output high voltage	2.03	V
V_{OL}	Output low voltage	1.27	V
V_{OD}	Output differential voltage	0.76	V
V_{CM}	Output common mode voltage	1.65	V
Z_{BACK}	Back impedance	85.7	ohm
I_{DC}	DC output current	12.7	mA

1. For input buffer, see LVDS table.

For further information about LVPECL, BLVDS and other differential interfaces please see the list of technical information at the end of this data sheet.

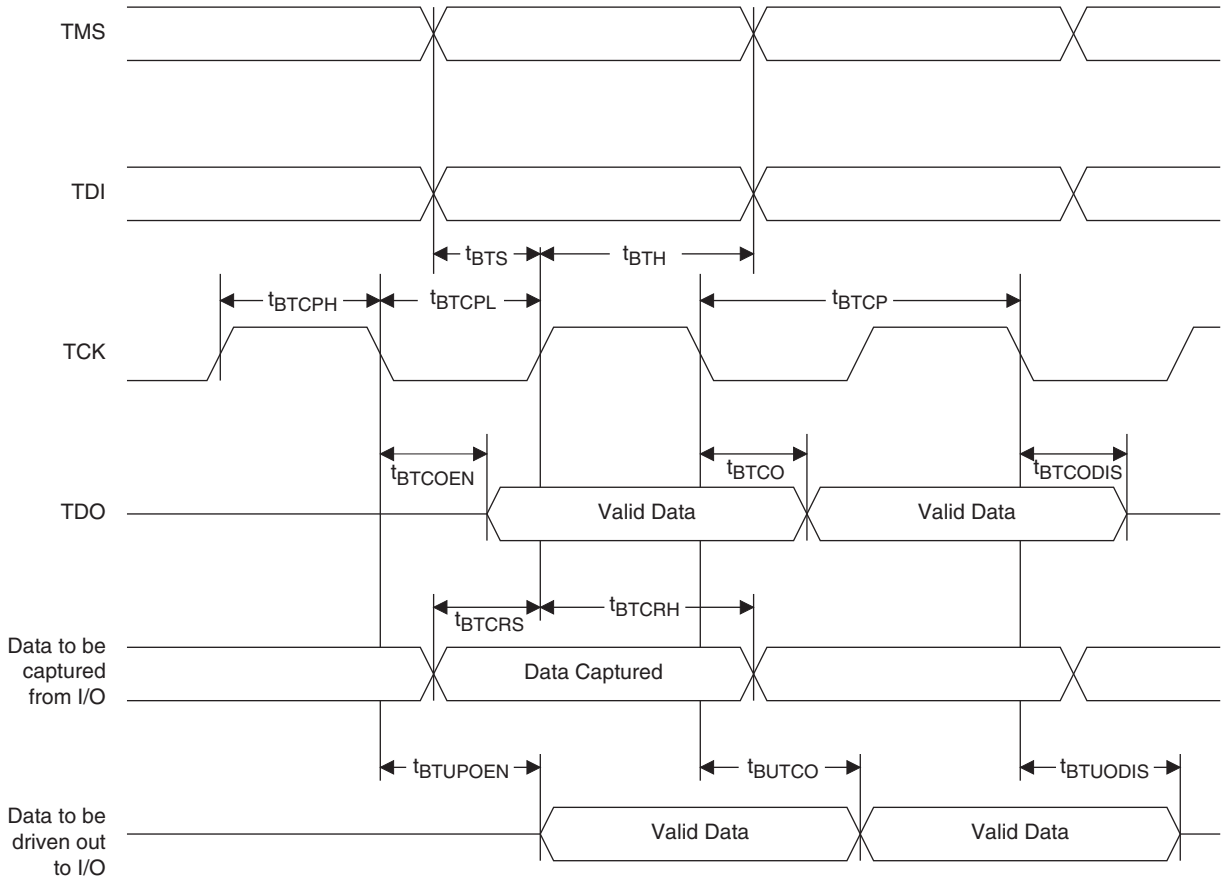
JTAG Port Timing Specifications

Over Recommended Operating Conditions

Symbol	Parameter	Min	Max	Units
f_{MAX}	TCK clock frequency	—	25	MHz
t_{BTCP}	TCK [BSCAN] clock pulse width	40	—	ns
t_{BTCPH}	TCK [BSCAN] clock pulse width high	20	—	ns
t_{BTCPL}	TCK [BSCAN] clock pulse width low	20	—	ns
t_{BTS}	TCK [BSCAN] setup time	8	—	ns
t_{BTH}	TCK [BSCAN] hold time	10	—	ns
t_{BTRF}	TCK [BSCAN] rise/fall time	50	—	mV/ns
t_{BTCO}	TAP controller falling edge of clock to valid output	—	10	ns
$t_{BTCODIS}$	TAP controller falling edge of clock to valid disable	—	10	ns
t_{BTCOEN}	TAP controller falling edge of clock to valid enable	—	10	ns
t_{BTCRS}	BSCAN test capture register setup time	8	—	ns
t_{BTCRH}	BSCAN test capture register hold time	25	—	ns
t_{BUTCO}	BSCAN test update register, falling edge of clock to valid output	—	25	ns
$t_{BTUODIS}$	BSCAN test update register, falling edge of clock to valid disable	—	25	ns
$t_{BTUPOEN}$	BSCAN test update register, falling edge of clock to valid enable	—	25	ns

Timing v.G 0.30

Figure 3-20. JTAG Port Timing Waveforms



Signal Descriptions

Signal Name	I/O	Description
General Purpose		
P[Edge] [Row/Column Number*]_[A/B]	I/O	[Edge] indicates the edge of the device on which the pad is located. Valid edge designations are L (Left), B (Bottom), R (Right), T (Top). [Row/Column Number] indicates the PFU row or the column of the device on which the PIC exists. When Edge is T (Top) or (Bottom), only need to specify Row Number. When Edge is L (Left) or R (Right), only need to specify Column Number. [A/B] indicates the PIO within the PIC to which the pad is connected. Some of these user-programmable pins are shared with special function pins. These pin when not used as special purpose pins can be programmed as I/Os for user logic. During configuration the user-programmable I/Os are tri-stated with an internal pull-up resistor enabled. If any pin is not used (or not bonded to a package pin), it is also tri-stated with an internal pull-up resistor enabled after configuration.
GSRN	I	Global RESET signal (active low). Any I/O pin can be GSRN.
NC	—	No connect.
GND	—	Ground. Dedicated pins.
V_{CC}	—	Power supply pins for core logic. Dedicated pins.
V_{CCAUX}	—	Auxiliary power supply pin. It powers all the differential and referenced input buffers. Dedicated pins.
V_{CCIOx}	—	Power supply pins for I/O bank x. Dedicated pins.
V_{REF1_x}, V_{REF2_x}	—	Reference supply pins for I/O bank x. Pre-determined pins in each bank are assigned as V_{REF} inputs. When not used, they may be used as I/O pins.
XRES	—	10K ohm +/-1% resistor must be connected between this pad and ground.
V_{CCPLL}	—	Power supply pin for PLL.þApplicable to ECP/EC33 device.
PLL and Clock Functions (Used as user programmable I/O pins when not in use for PLL or clock pins)		
[LOC][num]_PLL[T, C]_IN_A	I	Reference clock (PLL) input pads: ULM, LLM, URM, LRM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_PLL[T, C]_FB_A	I	Optional feedback (PLL) input pads: ULM, LLM, URM, LRM, num = row from center, T = true and C = complement, index A,B,C...at each side.
PCLK[T, C]_[n:0]_[3:0]	I	Primary Clock pads, T = true and C = complement, n per side, indexed by bank and 0,1,2,3 within bank.
[LOC]DQS[num]	I	DQS input pads: T (Top), R (Right), B (Bottom), L (Left), DQS, num = ball function number. Any pad can be configured to be output.
Test and Programming (Dedicated pins)		
TMS	I	Test Mode Select input, used to control the 1149.1 state machine. Pull-up is enabled during configuration.
TCK	I	Test Clock input pin, used to clock the 1149.1 state machine. No pull-up enabled.

PICs and DDR Data (DQ) Pins Associated with the DDR Strobe (DQS) Pin

PICs Associated with DQS Strobe	PIO Within PIC	DDR Strobe (DQS) and Data (DQ) Pins
P[Edge] [n-4]	A	DQ
	B	DQ
P[Edge] [n-3]	A	DQ
	B	DQ
P[Edge] [n-2]	A	DQ
	B	DQ
P[Edge] [n-1]	A	DQ
	B	DQ
P[Edge] [n]	A	[Edge]DQSn
	B	DQ
P[Edge] [n+1]	A	DQ
	B	DQ
P[Edge] [n+2]	A	DQ
	B	DQ
P[Edge] [n+3]	A	DQ
	B	DQ

Notes:
1. “n” is a Row/Column PIC number
2. The DDR interface is designed for memories that support one DQS strobe per eight bits of data. In some packages, all the potential DDR data (DQ) pins may not be available.
3. PIC numbering definitions are provided in the “Signal Names” column of the Signal Descriptions table.

Power Supply and NC Connections (Cont.)

Signals	484 fpBGA	672 fpBGA
VCC	J16, J7, K16, K17, K6, K7, L17, L6, M17, M6, N16, N17, N6, N7, P16, P7, J6, J17, P6, P17	H10, H11, H16, H17, H18, H19, H8, H9, J18, J9, K8, L19, M19, N7, R20, R7, T19, V18, V8, V9, W10, W11, W16, W17, W18, W19, W8, W9, K19, L8, U19, U8
VCCIO0	G11, H10, H11, H9	H12, H13, J10, J11, J12, J13
VCCIO1	G12, H12, H13, H14	H14, H15, J14, J15, J16, J17
VCCIO2	J15, K15, L15, L16	K17, K18, L18, M18, N18, N19
VCCIO3	M15, M16, N15, P15	P18, P19, R18, R19, T18, U18
VCCIO4	R12, R13, R14, T12	V14, V15, V16, V17, W14, W15
VCCIO5	R10, R11, R9, T11	V10, V11, V12, V13, W12, W13
VCCIO6	M7, M8, N8, P8	P8, P9, R8, R9, T9, U9
VCCIO7	J8, K8, L7, L8	K9, L9, M8, M9, N8, N9
VCCJ	U2	U6
VCCAUX	G15, G16, G7, G8, H16, H7, R16, R7, T15, T16, T7, T8	G13, H20, H7, J19, J8, K7, L20, M20, M7, N20, P20, P7, T20, T7, T8, V19, V7, W20, Y13, Y7
VCCPLL	**ECP/EC20:** None **ECP/EC33:** J6, J17, P6, P17	**ECP/EC20**: None **ECP/EC33**: K19, L8, U19, U8
GND, GND0-GND7	A1, A22, AB1, AB22, H15, H8, J10, J11, J12, J13, J14, J9, K10, K11, K12, K13, K14, K9, L10, L11, L12, L13, L14, L9, M10, M11, M12, M13, M14, M9, N10, N11, N12, N13, N14, N9, P10, P11, P12, P13, P14, P9, R15, R8	K10, K11, K12, K13, K14, K15, K16, L10, L11, L12, L13, L14, L15, L16, L17, M10, M11, M12, M13, M14, M15, M16, M17, N10, N11, N12, N13, N14, N15, N16, N17, P10, P11, P12, P13, P14, P15, P16, P17, R10, R11, R12, R13, R14, R15, R16, R17, T10, T11, T12, T13, T14, T15, T16, T17, U10, U11, U12, U13, U14, U15, U16, U17
NC	**ECP/EC6:** C3, B2, E5, F5, D3, C2, F4, G4, E3, D2, B1, C1, F3, E2, G5, H6, G3, H4, J5, H5, F2, F1, E1, D1, R6, P5, P3, P4, R1, R2, R5, R4, T1, T2, R3, T3, V7, T6, V8, U7, W5, U6, AA3, AB3, Y6, V6, AA5, W6, Y5, Y4, AA4, AB4, W16, U15, V16, U16, Y17, V17, AB20, AA19, Y16, W17, AA20, Y19, Y18, W18, T17, U17, T18, R17, R19, R18, U22, T22, R21, R22, P20, N20, P19, P18, E21, D22, G21, G20, J18, H19, J19, H20, H17, H18, D21, C22, G19, G18, F20, F19, E20, D20, C21, C20, F18, E18, B22, B21, G17, F17, D18, C18, C19, B20, D17, C16, B19, A20, E17, C17, F16, E16, F15, D16, A4, B4, C4, C5, D6, B5, E6, C6, A3, B3, F6, D5, F7, E8, G6, E7, A2, AB2, A21 **ECP/EC10:** G5, H6, G3, H4, J5, H5, F2, F1, R6, P5, P3, P4, R2, R1, R5, R4, T1, T2, R3, T3, W16, U15, V16, U16, Y17, V17, AB20, AA19, Y16, W17, AA20, Y19, Y18, W18, T17, U17, T18, R17, R19, R18, U22, T22, R21, R22, P20, N20, P19, P18, G21, G20, J18, H19, J19, H20, H17, H18, G17, F17, D18, C18, C19, B20, D17, C16, B19, A20, E17, C17, F16, E16, F15, D16, A2, AB2, A21 **ECP/EC15:** T1, T2, R3, T3, T18, R17, R19, R18, A2, AB2, A21 **ECP/EC20:** A2, AB2, A21 **ECP/EC33:** A2, AB2, A21	**ECP/EC20:** E5, D5, F4, F5, C3, D3, C2, B2, H6, J7, G5, H5, H3, J3, H2, J2, AA2, AA3, W5, Y5, Y6, W7, AA4, AB3, AC2, AC3, AA5, AB5, AD3, AD2, AE1, AD1, AD19, AD20, AC19, AB19, AD21, AC20, AF25, AE25, AB21, AB20, AE24, AD23, AD22, AC21, AC22, AB22, AD24, AD25, AE26, AD26, Y20, Y19, AA23, AA22, AB23, AB24, Y21, AA21, Y23, Y22, AA24, Y24, J21, J22, J23, H22, G26, F26, E26, E25, F24, F23, E24, D24, E22, F22, E21, D22, G20, F20, D21, C21, C23, C22, B23, C24, D20, E19, B25, B24, B26, A25, C20, C19 **ECP/EC33:** None

LFEC1, LFEC3 Logic Signal Connections: 100 TQFP (Cont.)

Pin Number	LFEC1				LFEC3			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
82	PT11B	1	C	VREF2_1	PT19B	1	C	VREF2_1
83	PT11A	1	T	VREF1_1	PT19A	1	T	VREF1_1
84	PT10B	1	C		PT18B	1	C	
85	PT10A	1	T		PT18A	1	T	
86	VCCIO1	1			VCCIO1	1		
87	VCCAUX	-			VCCAUX	-		
88	PT9B	0	C	PCLKC0_0	PT17B	0	C	PCLKC0_0
89	GND0	0			GND0	0		
90	PT9A	0	T	PCLKT0_0	PT17A	0	T	PCLKT0_0
91	PT8B	0	C	VREF1_0	PT16B	0	C	VREF1_0
92	PT8A	0	T	VREF2_0	PT16A	0	T	VREF2_0
93	PT7B	0			PT15B	0		
94	PT6B	0	C		PT14B	0	C	
95	PT6A	0	T	TDQS6	PT14A	0	T	TDQS14
96	PT4B	0	C		PT12B	0	C	
97	PT4A	0	T		PT12A	0	T	
98	PT2B	0	C		PT10B	0	C	
99	PT2A	0	T		PT10A	0	T	
100	VCCIO0	0			VCCIO0	0		

*Double bonded to the pin.

LFEC3 and LFECP/EC6 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFEC3				LFECP6/LFEC6			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
K2	PL11A	6	T	LLM0_PLLT_IN_A	PL20A	6	T	LLM0_PLLT_IN_A
K1	PL11B	6	C	LLM0_PLLC_IN_A	PL20B	6	C	LLM0_PLLC_IN_A
L2	PL12A	6	T	LLM0_PLLT_FB_A	PL21A	6	T	LLM0_PLLT_FB_A
L1	PL12B	6	C	LLM0_PLLC_FB_A	PL21B	6	C	LLM0_PLLC_FB_A
M2	PL13A	6	T		PL22A	6	T	
M1	PL13B	6	C		PL22B	6	C	
N1	PL14A	6	T		PL23A	6	T	
GND	GND6	6			GND6	6		
N2	PL14B	6	C		PL23B	6	C	
M4	PL15A	6	T	LDQS15	PL24A	6	T	LDQS24
M3	PL15B	6	C		PL24B	6	C	
P1	PL16A	6	T		PL25A	6	T	
R1	PL16B	6	C		PL25B	6	C	
P2	PL17A	6	T		PL26A	6	T	
P3	PL17B	6	C		PL26B	6	C	
N3	PL18A	6	T	VREF1_6	PL27A	6	T	VREF1_6
N4	PL18B	6	C	VREF2_6	PL27B	6	C	VREF2_6
GND	GND6	6			GND6	6		
GND	GND5	5			GND5	5		
P4	PB2A	5	T		PB2A	5	T	
N5	PB2B	5	C		PB2B	5	C	
P5	PB3A	5	T		PB3A	5	T	
P6	PB3B	5	C		PB3B	5	C	
R4	PB4A	5	T		PB4A	5	T	
R3	PB4B	5	C		PB4B	5	C	
T2	PB5A	5	T		PB5A	5	T	
T3	PB5B	5	C		PB5B	5	C	
R5	PB6A	5	T	BDQS6	PB6A	5	T	BDQS6
R6	PB6B	5	C		PB6B	5	C	
T4	PB7A	5	T		PB7A	5	T	
T5	PB7B	5	C		PB7B	5	C	
N6	PB8A	5	T		PB8A	5	T	
M6	PB8B	5	C		PB8B	5	C	
T6	PB9A	5	T		PB9A	5	T	
GND	GND5	5			GND5	5		
T7	PB9B	5	C		PB9B	5	C	
P7	PB10A	5	T		PB10A	5	T	
N7	PB10B	5	C		PB10B	5	C	
R7	PB11A	5	T		PB11A	5	T	
R8	PB11B	5	C		PB11B	5	C	
M7	PB12A	5	T		PB12A	5	T	
M8	PB12B	5	C		PB12B	5	C	
T8	PB13A	5	T		PB13A	5	T	

LFEC3 and LFECP/EC6 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFEC3				LFECP6/LFEC6			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
C16	PR4B	2	C		PR4B	2	C	
B16	PR4A	2	T		PR4A	2	T	
C15	PR3B	2	C		PR3B	2	C	
C14	PR3A	2	T		PR3A	2	T	
D14	PR2B	2	C	VREF1_2	PR2B	2	C	VREF1_2
D13	PR2A	2	T	VREF2_2	PR2A	2	T	VREF2_2
GND	GND2	2			GND2	2		
GND	GND1	1			GND1	1		
-	-	-			GND1	1		
B13	NC	-			PT26B	1	C	
C13	NC	-			PT26A	1	T	
C12	PT25B	1	C		PT25B	1	C	
-	-	-			GND1	1		
D12	PT25A	1	T		PT25A	1	T	
A15	PT24B	1	C		PT24B	1	C	
B14	PT24A	1	T		PT24A	1	T	
D11	PT23B	1	C		PT23B	1	C	
C11	PT23A	1	T		PT23A	1	T	
E10	PT22B	1	C		PT22B	1	C	
E11	PT22A	1	T	TDQS22	PT22A	1	T	TDQS22
A14	PT21B	1	C		PT21B	1	C	
GND	GND1	1			GND1	1		
A13	PT21A	1	T		PT21A	1	T	
D10	PT20B	1	C		PT20B	1	C	
C10	PT20A	1	T		PT20A	1	T	
A12	PT19B	1	C	VREF2_1	PT19B	1	C	VREF2_1
B12	PT19A	1	T	VREF1_1	PT19A	1	T	VREF1_1
A11	PT18B	1	C		PT18B	1	C	
B11	PT18A	1	T		PT18A	1	T	
A10	PT17B	0	C	PCLKC0_0	PT17B	0	C	PCLKC0_0
GND	GND0	0			GND0	0		
B10	PT17A	0	T	PCLKT0_0	PT17A	0	T	PCLKT0_0
C9	PT16B	0	C	VREF1_0	PT16B	0	C	VREF1_0
B9	PT16A	0	T	VREF2_0	PT16A	0	T	VREF2_0
E9	PT15B	0	C		PT15B	0	C	
D9	PT15A	0	T		PT15A	0	T	
D8	PT14B	0	C		PT14B	0	C	
C8	PT14A	0	T	TDQS14	PT14A	0	T	TDQS14
A9	PT13B	0	C		PT13B	0	C	
GND	GND0	0			GND0	0		
A8	PT13A	0	T		PT13A	0	T	
B8	PT12B	0	C		PT12B	0	C	
B7	PT12A	0	T		PT12A	0	T	

LFECP/EC6, LFECP/EC10, LFECP/EC15 Logic Signal Connections: 484 fpBGA

LFECP6/LFEC6					LFECP10/LFEC10					LFECP/LFEC15				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
GND	GND7	7			GND	GND7	7			GND	GND7	7		
D4	PL2A	7	T	VREF2_7	D4	PL2A	7	T	VREF2_7	D4	PL2A	7	T	VREF2_7
E4	PL2B	7	C	VREF1_7	E4	PL2B	7	C	VREF1_7	E4	PL2B	7	C	VREF1_7
C3	NC	-			C3	PL3A	7	T		C3	PL3A	7	T	
B2	NC	-			B2	PL3B	7	C		B2	PL3B	7	C	
E5	NC	-			E5	PL4A	7	T		E5	PL4A	7	T	
F5	NC	-			F5	PL4B	7	C		F5	PL4B	7	C	
D3	NC	-			D3	PL5A	7	T		D3	PL5A	7	T	
C2	NC	-			C2	PL5B	7	C		C2	PL5B	7	C	
F4	NC	-			F4	PL6A	7	T	LDQS6	F4	PL6A	7	T	LDQS6
G4	NC	-			G4	PL6B	7	C		G4	PL6B	7	C	
E3	NC	-			E3	PL7A	7	T		E3	PL7A	7	T	
D2	NC	-			D2	PL7B	7	C		D2	PL7B	7	C	
B1	NC	-			B1	PL8A	7	T	LUM0_PLLT_IN_A	B1	PL8A	7	T	LUM0_PLLT_IN_A
C1	NC	-			C1	PL8B	7	C	LUM0_PLLC_IN_A	C1	PL8B	7	C	LUM0_PLLC_IN_A
F3	NC	-			F3	PL9A	7	T	LUM0_PLLT_FB_A	F3	PL9A	7	T	LUM0_PLLT_FB_A
GND	-	-			GND	GND7	7			GND	GND7	7		
E2	NC	-			E2	PL9B	7	C	LUM0_PLLC_FB_A	E2	PL9B	7	C	LUM0_PLLC_FB_A
G5	NC	-			G5	NC	-			G5	PL11A	7	T	
H6	NC	-			H6	NC	-			H6	PL11B	7	C	
G3	NC	-			G3	NC	-			G3	PL12A	7	T	
H4	NC	-			H4	NC	-			H4	PL12B	7	C	
J5	NC	-			J5	NC	-			J5	PL13A	7	T	
H5	NC	-			H5	NC	-			H5	PL13B	7	C	
F2	NC	-			F2	NC	-			F2	PL14A	7	T	
GND	-	-			GND	-	-			GND	GND7	7		
F1	NC	-			F1	NC	-			F1	PL14B	7	C	
E1	NC	-			E1	PL11A	7	T		E1	PL15A	7	T	
D1	NC	-			D1	PL11B	7	C		D1	PL15B	7	C	
H3	PL3A	7	T		H3	PL12A	7	T		H3	PL16A	7	T	
G2	PL3B	7	C		G2	PL12B	7	C		G2	PL16B	7	C	
H2	PL4A	7	T		H2	PL13A	7	T		H2	PL17A	7	T	
G1	PL4B	7	C		G1	PL13B	7	C		G1	PL17B	7	C	
J4	PL5A	7	T		J4	PL14A	7	T		J4	PL18A	7	T	
GND	-	-			GND	GND7	7			GND	GND7	7		
J3	PL5B	7	C		J3	PL14B	7	C		J3	PL18B	7	C	
J2	PL6A	7	T	LDQS6	J2	PL15A	7	T	LDQS15	J2	PL19A	7	T	LDQS19
H1	PL6B	7	C		H1	PL15B	7	C		H1	PL19B	7	C	
K4	PL7A	7	T		K4	PL16A	7	T		K4	PL20A	7	T	
K5	PL7B	7	C		K5	PL16B	7	C		K5	PL20B	7	C	
K3	PL8A	7	T		K3	PL17A	7	T		K3	PL21A	7	T	
K2	PL8B	7	C		K2	PL17B	7	C		K2	PL21B	7	C	
J1	PL9A	7	T	PCLKT7_0	J1	PL18A	7	T	PCLKT7_0	J1	PL22A	7	T	PCLKT7_0
GND	GND7	7			GND	GND7	7			GND	GND7	7		
K1	PL9B	7	C	PCLKC7_0	K1	PL18B	7	C	PCLKC7_0	K1	PL22B	7	C	PCLKC7_0
L3	XRES	6			L3	XRES	6			L3	XRES	6		
L4	PL11A	6	T		L4	PL20A	6	T		L4	PL24A	6	T	
L5	PL11B	6	C		L5	PL20B	6	C		L5	PL24B	6	C	
L2	PL12A	6	T		L2	PL21A	6	T		L2	PL25A	6	T	
L1	PL12B	6	C		L1	PL21B	6	C		L1	PL25B	6	C	

LFECP/EC6, LFECP/EC10, LFECP/EC15 Logic Signal Connections: 484 fpBGA (Cont.)

LFECP6/LFEC6					LFECP10/LFEC10					LFECP/LFEC15				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
GND	GND5	5			GND	GND5	5			GND	GND5	5		
V7	NC	-			V7	PB2A	5	T		V7	PB2A	5	T	
T6	NC	-			T6	PB2B	5	C		T6	PB2B	5	C	
V8	NC	-			V8	PB3A	5	T		V8	PB3A	5	T	
U7	NC	-			U7	PB3B	5	C		U7	PB3B	5	C	
W5	NC	-			W5	PB4A	5	T		W5	PB4A	5	T	
U6	NC	-			U6	PB4B	5	C		U6	PB4B	5	C	
AA3	NC	-			AA3	PB5A	5	T		AA3	PB5A	5	T	
AB3	NC	-			AB3	PB5B	5	C		AB3	PB5B	5	C	
Y6	NC	-			Y6	PB6A	5	T	BDQS6	Y6	PB6A	5	T	BDQS6
V6	NC	-			V6	PB6B	5	C		V6	PB6B	5	C	
AA5	NC	-			AA5	PB7A	5	T		AA5	PB7A	5	T	
W6	NC	-			W6	PB7B	5	C		W6	PB7B	5	C	
Y5	NC	-			Y5	PB8A	5	T		Y5	PB8A	5	T	
Y4	NC	-			Y4	PB8B	5	C		Y4	PB8B	5	C	
AA4	NC	-			AA4	PB9A	5	T		AA4	PB9A	5	T	
GND	-	-			GND	GND5	5			GND	GND5	5		
AB4	NC	-			AB4	PB9B	5	C		AB4	PB9B	5	C	
Y7	PB2A	5	T		Y7	PB10A	5	T		Y7	PB10A	5	T	
W8	PB2B	5	C		W8	PB10B	5	C		W8	PB10B	5	C	
W7	PB3A	5	T		W7	PB11A	5	T		W7	PB11A	5	T	
U8	PB3B	5	C		U8	PB11B	5	C		U8	PB11B	5	C	
W9	PB4A	5	T		W9	PB12A	5	T		W9	PB12A	5	T	
U9	PB4B	5	C		U9	PB12B	5	C		U9	PB12B	5	C	
Y8	PB5A	5	T		Y8	PB13A	5	T		Y8	PB13A	5	T	
GND	-	-			GND	GND5	5			GND	GND5	5		
Y9	PB5B	5	C		Y9	PB13B	5	C		Y9	PB13B	5	C	
V9	PB6A	5	T	BDQS6	V9	PB14A	5	T	BDQS14	V9	PB14A	5	T	BDQS14
T9	PB6B	5	C		T9	PB14B	5	C		T9	PB14B	5	C	
W10	PB7A	5	T		W10	PB15A	5	T		W10	PB15A	5	T	
U10	PB7B	5	C		U10	PB15B	5	C		U10	PB15B	5	C	
V10	PB8A	5	T		V10	PB16A	5	T		V10	PB16A	5	T	
T10	PB8B	5	C		T10	PB16B	5	C		T10	PB16B	5	C	
AA6	PB9A	5	T		AA6	PB17A	5	T		AA6	PB17A	5	T	
GND	GND5	5			GND	GND5	5			GND	GND5	5		
AB5	PB9B	5	C		AB5	PB17B	5	C		AB5	PB17B	5	C	
AA8	PB10A	5	T		AA8	PB18A	5	T		AA8	PB18A	5	T	
AA7	PB10B	5	C		AA7	PB18B	5	C		AA7	PB18B	5	C	
AB6	PB11A	5	T		AB6	PB19A	5	T		AB6	PB19A	5	T	
AB7	PB11B	5	C		AB7	PB19B	5	C		AB7	PB19B	5	C	
Y10	PB12A	5	T		Y10	PB20A	5	T		Y10	PB20A	5	T	
W11	PB12B	5	C		W11	PB20B	5	C		W11	PB20B	5	C	
AB8	PB13A	5	T		AB8	PB21A	5	T		AB8	PB21A	5	T	
GND	GND5	5			GND	GND5	5			GND	GND5	5		
AB9	PB13B	5	C		AB9	PB21B	5	C		AB9	PB21B	5	C	
AA10	PB14A	5	T	BDQS14	AA10	PB22A	5	T	BDQS22	AA10	PB22A	5	T	BDQS22
AA9	PB14B	5	C		AA9	PB22B	5	C		AA9	PB22B	5	C	
Y11	PB15A	5	T		Y11	PB23A	5	T		Y11	PB23A	5	T	
AA11	PB15B	5	C		AA11	PB23B	5	C		AA11	PB23B	5	C	
V11	PB16A	5	T	VREF2_5	V11	PB24A	5	T	VREF2_5	V11	PB24A	5	T	VREF2_5

LFECP/EC20 and LFECP/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFECP20/LFEC20					LFECP/LFEC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
L7	VCCIO7	7			L7	VCCIO7	7		
L8	VCCIO7	7			L8	VCCIO7	7		
G15	VCCAUX	-			G15	VCCAUX	-		
G16	VCCAUX	-			G16	VCCAUX	-		
G7	VCCAUX	-			G7	VCCAUX	-		
G8	VCCAUX	-			G8	VCCAUX	-		
H16	VCCAUX	-			H16	VCCAUX	-		
H7	VCCAUX	-			H7	VCCAUX	-		
R16	VCCAUX	-			R16	VCCAUX	-		
R7	VCCAUX	-			R7	VCCAUX	-		
T15	VCCAUX	-			T15	VCCAUX	-		
T16	VCCAUX	-			T16	VCCAUX	-		
T7	VCCAUX	-			T7	VCCAUX	-		
T8	VCCAUX	-			T8	VCCAUX	-		
J6	VCC[1]	-			J6	VCCPLL	-		
J17	VCC[1]	-			J17	VCCPLL	-		
P6	VCC[1]	-			P6	VCCPLL	-		
P17	VCC[1]	-			P17	VCCPLL	-		
A2	NC	-			A2	NC	-		
AB2	NC	-			AB2	NC	-		
A21	NC	-			A21	NC	-		

1. Tied to V_{CCPLL}.

LatticeEC Industrial (Continued)

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC15E-3F484I	352	-3	fpBGA	484	IND	15.3K
LFEC15E-4F484I	352	-4	fpBGA	484	IND	15.3K
LFEC15E-3F256I	195	-3	fpBGA	256	IND	15.3K
LFEC15E-4F256I	195	-4	fpBGA	256	IND	15.3K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC20E-3F672I	400	-3	fpBGA	672	IND	19.7K
LFEC20E-4F672I	400	-4	fpBGA	672	IND	19.7K
LFEC20E-3F484I	360	-3	fpBGA	484	IND	19.7K
LFEC20E-4F484I	360	-4	fpBGA	484	IND	19.7K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC33E-3F672I	496	-3	fpBGA	672	IND	32.8
LFEC33E-4F672I	496	-4	fpBGA	672	IND	32.8
LFEC33E-3F484I	360	-3	fpBGA	484	IND	32.8
LFEC33E-4F484I	360	-4	fpBGA	484	IND	32.8

LatticeECP Industrial

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFECP6E-3F484I	224	-3	fpBGA	484	IND	6.1K
LFECP6E-4F484I	224	-4	fpBGA	484	IND	6.1K
LFECP6E-3F256I	195	-3	fpBGA	256	IND	6.1K
LFECP6E-4F256I	195	-4	fpBGA	256	IND	6.1K
LFECP6E-3Q208I	147	-3	PQFP	208	IND	6.1K
LFECP6E-4Q208I	147	-4	PQFP	208	IND	6.1K
LFECP6E-3T144I	97	-3	TQFP	144	IND	6.1K
LFECP6E-4T144I	97	-4	TQFP	144	IND	6.1K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFECP10E-3F484I	288	-3	fpBGA	484	IND	10.2K
LFECP10E-4F484I	288	-4	fpBGA	484	IND	10.2K
LFECP10E-3F256I	195	-3	fpBGA	256	IND	10.2K
LFECP10E-4F256I	195	-4	fpBGA	256	IND	10.2K
LFECP10E-3Q208I	147	-3	PQFP	208	IND	10.2K
LFECP10E-4Q208I	147	-4	PQFP	208	IND	10.2K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFECP15E-3F484I	352	-3	fpBGA	484	IND	15.3K
LFECP15E-4F484I	352	-4	fpBGA	484	IND	15.3K
LFECP15E-3F256I	195	-3	fpBGA	256	IND	15.3K
LFECP15E-4F256I	195	-4	fpBGA	256	IND	15.3K

LatticeECP Commercial

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFECP6E-3FN484C	224	-3	Lead-Free fpBGA	484	COM	6.1K
LFECP6E-4FN484C	224	-4	Lead-Free fpBGA	484	COM	6.1K
LFECP6E-5FN484C	224	-5	Lead-Free fpBGA	484	COM	6.1K
LFECP6E-3FN256C	195	-3	Lead-Free fpBGA	256	COM	6.1K
LFECP6E-4FN256C	195	-4	Lead-Free fpBGA	256	COM	6.1K
LFECP6E-5FN256C	195	-5	Lead-Free fpBGA	256	COM	6.1K
LFECP6E-3QN208C	147	-3	Lead-Free PQFP	208	COM	6.1K
LFECP6E-4QN208C	147	-4	Lead-Free PQFP	208	COM	6.1K
LFECP6E-5QN208C	147	-5	Lead-Free PQFP	208	COM	6.1K
LFECP6E-3TN144C	97	-3	Lead-Free TQFP	144	COM	6.1K
LFECP6E-4TN144C	97	-4	Lead-Free TQFP	144	COM	6.1K
LFECP6E-5TN144C	97	-5	Lead-Free TQFP	144	COM	6.1K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFECP10E-3FN484C	288	-3	Lead-Free fpBGA	484	COM	10.2K
LFECP10E-4FN484C	288	-4	Lead-Free fpBGA	484	COM	10.2K
LFECP10E-5FN484C	288	-5	Lead-Free fpBGA	484	COM	10.2K
LFECP10E-3FN256C	195	-3	Lead-Free fpBGA	256	COM	10.2K
LFECP10E-4FN256C	195	-4	Lead-Free fpBGA	256	COM	10.2K
LFECP10E-5FN256C	195	-5	Lead-Free fpBGA	256	COM	10.2K
LFECP10E-3QN208C	147	-3	Lead-Free PQFP	208	COM	10.2K
LFECP10E-4QN208C	147	-4	Lead-Free PQFP	208	COM	10.2K
LFECP10E-5QN208C	147	-5	Lead-Free PQFP	208	COM	10.2K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFECP15E-3FN484C	352	-3	Lead-Free fpBGA	484	COM	15.3K
LFECP15E-4FN484C	352	-4	Lead-Free fpBGA	484	COM	15.3K
LFECP15E-5FN484C	352	-5	Lead-Free fpBGA	484	COM	15.3K
LFECP15E-3FN256C	195	-3	Lead-Free fpBGA	256	COM	15.3K
LFECP15E-4FN256C	195	-4	Lead-Free fpBGA	256	COM	15.3K
LFECP15E-5FN256C	195	-5	Lead-Free fpBGA	256	COM	15.3K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFECP20E-3FN672C	400	-3	Lead-Free fpBGA	672	COM	19.7K
LFECP20E-4FN672C	400	-4	Lead-Free fpBGA	672	COM	19.7K
LFECP20E-5FN672C	400	-5	Lead-Free fpBGA	672	COM	19.7K
LFECP20E-3FN484C	400	-3	Lead-Free fpBGA	484	COM	19.7K
LFECP20E-4FN484C	400	-4	Lead-Free fpBGA	484	COM	19.7K
LFECP20E-5FN484C	400	-5	Lead-Free fpBGA	484	COM	19.7K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFECP33E-3FN672C	496	-3	Lead-Free fpBGA	672	COM	32.8K
LFECP33E-4FN672C	496	-4	Lead-Free fpBGA	672	COM	32.8K
LFECP33E-5FN672C	496	-5	Lead-Free fpBGA	672	COM	32.8K

LatticeEC Industrial (Continued)

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC15E-3FN484I	352	-3	Lead-Free fpBGA	484	IND	15.3K
LFEC15E-4FN484I	352	-4	Lead-Free fpBGA	484	IND	15.3K
LFEC15E-3FN256I	195	-3	Lead-Free fpBGA	256	IND	15.3K
LFEC15E-4FN256I	195	-4	Lead-Free fpBGA	256	IND	15.3K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC20E-3FN672I	400	-3	Lead-Free fpBGA	672	IND	19.7K
LFEC20E-4FN672I	400	-4	Lead-Free fpBGA	672	IND	19.7K
LFEC20E-3FN484I	400	-3	Lead-Free fpBGA	484	IND	19.7K
LFEC20E-4FN484I	400	-4	Lead-Free fpBGA	484	IND	19.7K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC33E-3FN672I	496	-3	Lead-Free fpBGA	672	IND	32.8K
LFEC33E-4FN672I	496	-4	Lead-Free fpBGA	672	IND	32.8K
LFEC33E-3FN484I	360	-3	Lead-Free fpBGA	484	IND	32.8K
LFEC33E-4FN484I	360	-4	Lead-Free fpBGA	484	IND	32.8K

LatticeECP Industrial

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFECP6E-3FN484I	224	-3	Lead-Free fpBGA	484	IND	6.1K
LFECP6E-4FN484I	224	-4	Lead-Free fpBGA	484	IND	6.1K
LFECP6E-3FN256I	195	-3	Lead-Free fpBGA	256	IND	6.1K
LFECP6E-4FN256I	195	-4	Lead-Free fpBGA	256	IND	6.1K
LFECP6E-3QN208I	147	-3	Lead-Free PQFP	208	IND	6.1K
LFECP6E-4QN208I	147	-4	Lead-Free PQFP	208	IND	6.1K
LFECP6E-3TN144I	97	-3	Lead-Free TQFP	144	IND	6.1K
LFECP6E-4TN144I	97	-4	Lead-Free TQFP	144	IND	6.1K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFECP10E-3FN484I	288	-3	Lead-Free fpBGA	484	IND	10.2K
LFECP10E-4FN484I	288	-4	Lead-Free fpBGA	484	IND	10.2K
LFECP10E-3FN256I	195	-3	Lead-Free fpBGA	256	IND	10.2K
LFECP10E-4FN256I	195	-4	Lead-Free fpBGA	256	IND	10.2K
LFECP10E-3QN208I	147	-3	Lead-Free PQFP	208	IND	10.2K
LFECP10E-4QN208I	147	-4	Lead-Free PQFP	208	IND	10.2K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFECP15E-3FN484I	352	-3	Lead-Free fpBGA	484	IND	15.3K
LFECP15E-4FN484I	352	-4	Lead-Free fpBGA	484	IND	15.3K
LFECP15E-3FN256I	195	-3	Lead-Free fpBGA	256	IND	15.3K
LFECP15E-4FN256I	195	-4	Lead-Free fpBGA	256	IND	15.3K

LatticeECP/EC Family Data Sheet Revision History

Revision History

Date	Version	Section	Change Summary
June 2004	01.0	—	Initial release.
August 2004	01.1	Introduction	Added new device LFECP/LFEC33 in Table 1-1.
		Architecture	Added New device LFECP/LFEC33 in Tables 2-9, 2-10 and 2-11.
		DC & Switching Characteristics	Added New device LFECP/LFEC33 on Supply current (Standby) tables.
			Added New device LFECP/LFEC33 on Initialization Supply current tables.
		Ordering Information	Added 33K Logic Capacity Device in Part Number Description section.
			Added EC33, ECP33 device: Industrial and Commercial to Part Number table.
			Corrected I/O counts in the part number tables for 100/144 TQFP and 208 PQFP packages to match Table 1-1 on page 1.
November 2004	01.3	Introduction	Changed DDR333 (166MHz) to DDR400 (200MHz)
			Added “RSDS” offering to the Features list: Flexible I/O Buffer
		Architecture	Added information about Secondary Clock Sources
			Added information about DCS
			Added a section on “Recommended Power-up Sequence”
			Updated Figure 2-24 “DQS Routing”
			Added DSP Block performance numbers to Table 2-11
			Added another row for RSDS in Table 2-13 and Table 2-14
		DC & Switching Characteristics	Updated new timing numbers
			Added numbers to derating table
			Added DC conditions to RSDS table
			Changed LVDS Max. V_{CCIO} to 2.625
			Added a row for RSDS in “Operating Condition” table
			Updated standby and initialization current table
			Added figure 3-12: sysConfig SPI port sequence
			Added DDR Timing Table and DDR Timings Figure 3-6
		Pinout Information	Added LFECP/EC6 to Pin Information
			Added LFECP/EC6 to Power Supply and NC Connections
			Added LFECP/EC6 144 TQFP Logic Signal Connections
			Added LFECP/EC6 208 PQFP Logic Signal Connections
			Added LFECP/EC6 256 fpBGA Logic Signal Connections
			Added LFECP/EC6 484 fpBGA Logic Signal Connections
		Ordering Information	Added 33K Logic Capacity Device in Part Number Description section.
			Added Part Number table for Commercial EC33.
			Added Part Number table for Commercial ECP33.
			Added Part Number table for Industrial EC33.
			Added Part Number table for Industrial ECP33.